제25회 한국반도체학술대회

 The 25<sup>th</sup> Korean Conference on Semiconductors

 2018년 2월 5일(월)-7일(수), 강원도 하이원리조트 컨벤션 호텔

## 2018년 2월 7일(수), 13:15-14:45 Room G (봉래II+III, 6층)

## G. Device & Process Modeling, Simulation and Reliability 분과

[WG3-G] Modeling and Simulation II - Device and Process

좌장: 최성진 교수(국민대학교), 홍성민 교수(GIST)

WG3-G-1 13:15-13:30	Physics-Based Capacitance Model of Drift Region in LDMOS and Its Implementation with BSIM4 Jun Hyeok Kim <sup>1</sup> , Chan Ho Park <sup>1</sup> , Sung Moo Kim <sup>1</sup> , Ji-Woon Yang <sup>2</sup> , and Geun Tae Kwon <sup>1</sup> <sup>1</sup> Technology Enabling Team, DB Hitek Co., Ltd., Department of Electronics & Information Engineering, Korea University
WG3-G-2 13:30-13:45	A Frequency Domain Solver for Maxwell's Equations and Drift-Diffusion Model Jaehyeong Jang and Sung-Min Hong School of Electrical Engineering and Computer Science, Gwangju Institute of Science and Technology
WG3-G-3 13:45-14:00	공정 산포 마진 예측을 위한 Process Emulation Tool과 통계적 분석법을 활용 한 Process Integration 모델링 Mi-Na Kim, Hyoung-Gyu Choi, Eun-Young Cheon, Seong-Dong Kim, Seokkiu Lee, and Sungjoo Hong Device modeling & Reliability Group, R&D Division, SK Hynix Inc
WG3-G-4 14:00-14:15	First Principles Approach to Analyze Defect-induced Multiphonon Transition at the Si-SiO <sub>2</sub> Interface Junsung Park and Sung-Min Hong <i>School of Electrical Engineering and Computer Science, GIST</i>
WG3-G-5 14:15-14:30	Characteristics for Self Heating Effects on Stacked Nanosheet FET Hyunsuk Kim, Dokyun Son, Ilho Myeong, Myounggon Kang, and Hyungcheol Shin ISRC and School of Electrical Engineering and Computer Science, Seoul National University
WG3-G-6 14:30-14:45	<b>Series Resistance Characterization of Junctionless Transistors</b> DY. Jeon <sup>1</sup> , S. J. Park <sup>2</sup> , M. Mouis <sup>3</sup> , S. Barraud <sup>4</sup> , GT. Kim <sup>2</sup> , and G. Ghibaudo <sup>3</sup> <sup>1</sup> Institute of Advanced Composite Materials, Korea Institute of Science and Technology, <sup>2</sup> School of Electrical Engineering, Korea University, <sup>3</sup> IMEP-LAHC, Grenoble INP, Minatec, <sup>4</sup> CEA-LETI Minatec